



High ESD-Protected, Fail-Safe, Single Supply RS-232 Transceivers

UM232EESE SOP16 UM232EEPE DIP16 UM232EEUE TSSOP16

General Description

The UM232EExE series are low power single supply RS232 interface. The device consists of two line drivers, two line receivers, and dual charge pump circuit. The device meets the requirements of TIA/EIA-232 standard and provides the electrical interface between an asynchronous communication controller and the serial-port connector. The on chip charge pump and four small external capacitors act as onboard DC to DC converter, allow chip operated from single 5V supply, eliminating the need for $\pm 10V$ power supplies, reduce cost and board space. The device operates at data signaling rates over 250kbps. The slew rate of driver is set internally less than $30V/\mu s$ and the receivers feature internal noise filtering, eliminating the need for external slew rate and filter capacitors for reliable operation. The driver inputs and receiver outputs are TTL and CMOS compatible. UM232EExE comes in 16 pin DIP, SOP and TSSOP packages, operating over the commercial and industrial temperature ranges.

The ESD tolerance has been upgraded on these devices to over ± 15 kV for both Human Body Model and IEC61000-4-2 Air Discharge Method, without latch-up. The device operates with four 0.1µF capacitors, reduce system cost and board space.

Applications

Features

- Notebook and Palmtop Computers
- Battery-Powered Equipments
- Hand-Held Equipments
- POS Terminals

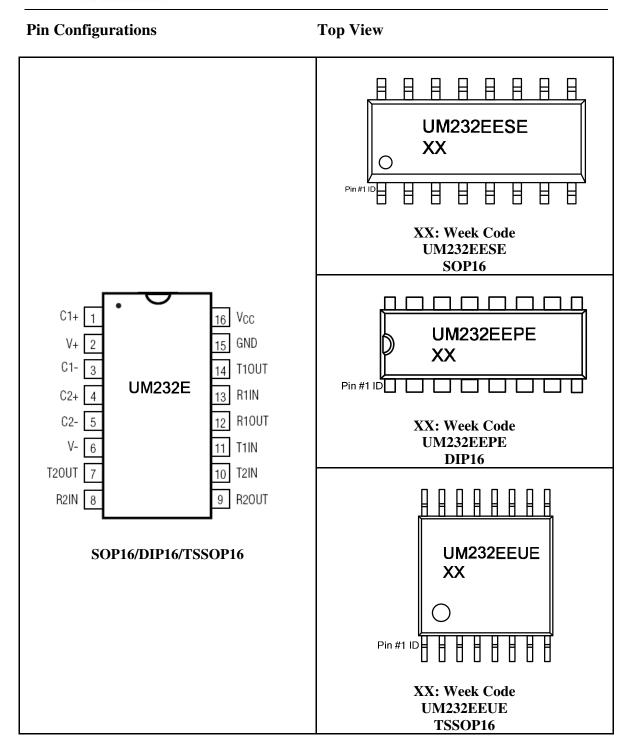
- ESD Protection for RS-232 Bus Pins up to ±15kV Human Body Model
- Single +5V Power Supply
- Low Power, I_{CC} 15mA Maximum
- Operates up to 250kbps
- Receiver Noise Filter
- Latch-Up Performance Exceeds 200mA

Ordering Information

Part Number	Temp. Range	Marking Code	Package Type	Shipping Qty
UM232EESE	-40°C to +85°C	UM232EESE	SOP16	2500pcs/13 Inch Tape & Reel
UM232EEPE	-40°C to +85°C	UM232EEPE	DIP16	25pcs/Tube
UM232EEUE	-40°C to +85°C	UM232EEUE	TSSOP16	3000pcs/13 Inch Tape & Reel



UM232EExE





Pin Descriptions

Pin No. SOP/DIP/TSSOP	Pin Name	Function
1,3	C1+, C1-	Terminals for Positive Charge Pump Capacitor
2	V+	+2V _{CC} Voltage Generated by the Charge Pump
4,5	C2+, C2-	Terminals for Negative Charge Pump Capacitor
6	V-	-2V _{CC} Voltage Generated by the Charge Pump
7,14	T_OUT	RS-232 Driver Outputs
8,13	R_IN	RS-232 Receiver Inputs
9,12	R_OUT	RS-232 Receiver Outputs
10,11	T_IN	RS-232 Driver Inputs
15	GND	Ground
16	V _{CC}	+4.5V to +5.5V Supply Voltage Input

Absolute Maximum Ratings (Note 1)

Symbol	Parameter	Value	Unit		
V _{CC}	Supply Voltage on V _{CO}	-0.3 to +6	V		
V_+	Voltage on V ₊	$(V_{CC} - 0.3)$ to +14	V		
V.	Voltage on V.		-14 to +0.3	V	
T_IN	Voltage on T_IN		-0.3 to $(V_{CC} + 0.3)$	V	
R_IN	Voltage on R_IN		± 30	V	
T_OUT	Voltage on T_OUT	$(V_{-} - 0.3)$ to $(V_{+} + 0.3)$	V		
R_OUT	Voltage on R_OUT	-0.3 to $(V_{CC} + 0.3)$	V		
	Short-Circuit Duration, T_	OUT	Continuous		
	SOP		696		
P _D	Continuous Power Dissipation at $T_A=70^{\circ}C$	DIP16	842	mW	
		TSSOP16	754.7]	
T _A	Operating Temperature Ra	ange	-40 to +85	°C	
T _{STG}	Storage Temperature Ran	-65 to +165	°C		
T _L	Maximum Lead Temperature for 10 Seconds	Soldering	+300	°C	

Note 1: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



Electrical Characteristics

(V_{CC}=+5V±10%, C1- C4=0.1µF, T_A=T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A=25°C)

$I_A=25^{\circ}C$	Symbol Conditions Min Typ Max						TI		
Parameter		Condit	Min	Тур	Max	Unit			
DC CHARACTERIST				1	10	1.5			
V _{CC} Supply Current	I _{CC}	No Load, T		10	15	mA			
LOGIC				1	1	+ 1.0			
Input Leakage Current		T_IN=0V				± 10	μA		
Input Threshold Low	V _{IL}	T_I		2.0		0.8	V		
Input Threshold High	V _{IH}	T_I	2.0			V			
Output Voltage Low	V _{OL}	R_OUT; I _{OU}			0.4	V			
Output Voltage High	V _{OH}	R_OUT; I _{OUT}	₁ =-1.0mA	3.5	V _{CC} -0.4		V		
Output Leakage Current		0V≤ROUT≤V _{CC}			±0.05	±10	μΑ		
EIA/TIA-232E RECEIVER INPUTS									
Input Voltage Range				-30		30	V		
Input Threshold Low		$T_A = +25^{\circ}C$, Normal $V_{CC} = 5V$ Operation		0.8	1.2		V		
Input Threshold High		$T_A = +25^{\circ}C,$	Normal Operation		1.7	2.4	V		
Input Hysteresis		V _{CC} =	5V	0.2	0.5	1.0	V		
Input Resistance		$T_A = +25^{\circ}C,$	V _{CC} =5V	3	5	7	kΩ		
EIA/TIA-232E TRANS	SMITTER								
Output Voltage Swing		All Drivers Loaded with 3kΩ to Ground		±5	±9		V		
Output Resistance		$V_{CC}=V+=V-=0V,$ $V_{OUT}=\pm 2V$		300			Ω		
Output Short-Circuit Current		Short to V _C or Other T				±70	mA		
TIMING CHARACTH	ERISTICS			-			-		
Maximum Data Rate		$R_L=3k\Omega$ t $C_L=50pF$ to One Transmitte	1000pF,	250			kbps		
Receiver Propagation Delay	t _{PLHR} , t _{PHLR}	C _L =150pF Figure 1	All Parts, Normal Operation		0.3		μs		
Transmitter Propagation Delay	t _{PLHT} , t _{PHLT}	R _L =3kΩ, C _L All Transmitte Figure	=2500pF, ers Loaded		1.2		μs		
Transition-Region Slew Rate		$\begin{array}{c} T_A = +25^{\circ}\text{C}, V_{CC} = 5\text{V}, \\ R_L = 3k\Omega \text{ to } 7k\Omega, \\ C_L = 50\text{pF to } 1000\text{pF}, \\ \text{Measured from -3V to } +3\text{V} \\ \text{or } +3\text{V to } -3\text{V}, \\ \text{Figure 1} \end{array}$			20	30	V/µs		
ESD PERFORMANC		CEIVER INPUT							
		Human Bod		±15					
ESD-Protection		IEC6100	IEC61000-4-2, Contact Discharge				kV		
Voltage		IEC6100 Air-Gap Di	0-4-2,		±15				



Detailed Description

The UM232EExE consists of three sections: charge-pump voltage converters, drivers, and receivers. These E versions provide extra protection against ESD. They survive ± 15 kV discharges to the RS-232 inputs and outputs, tested using the Human Body Model. When tested according to IEC61000-4-2, they survive ± 8 kV contact-discharges and ± 15 kV air-gap discharges. The rugged E versions are intended for use in harsh environments or applications where the RS-232 connection is frequently changed. The UM232EExE devices have internal charge pump voltage converters which allow them to operate from a single ± 5 V supply. The charge pumps will operate with polarized or non-polarized capacitors ranging from 0.1 to 10µF and will generate the ± 9 V needed to generate the RS-232 output levels.

RS-232 Drivers

The drivers are inverting transmitters, which accept TTL or CMOS inputs and output RS-232 signals with an inverted sense relative to the input logic levels. Typically the RS-232 output voltage swing is $\pm 9V$. Even under worst case loading conditions of $3k\Omega$ and 2500pF, the output is guaranteed to be $\pm 5V$, which is consistent with the RS-232 standard specifications. The transmitter outputs are protected against infinite short-circuits to ground without degradation in reliability. The instantaneous slew rate of the transmitter output is internally limited to a maximum of $30V/\mu s$ in order to meet the RS-232 standard. The smooth transition of the loaded output from V_{OL} to V_{OH} clearly meets the monotonicity requirements of the RS-232 standard.

RS-232 Receivers

The receivers convert RS-232 input signals to inverted TTL signals. The input thresholds are 0.8V minimum and 2.4V maximum, again well within the 3V RS-232 requirements. The receiver inputs are also protected against voltage up to 30V. A 5k Ω pull down resistor to ground will commit the output of the receiver to a high state when the pin is float. In actual system applications, it is quite possible for signals to be applied to the receiver inputs before power is applied the receiver circuitry. This occurs, for example, when a PC user attempts to print, only to realize the printer wasn't turned on. In this case an RS-232 signal from the PC will appear on the receiver input at the printer. When the printer power is turned on, the receiver will operate normally. All of these enhanced devices are fully protected.

ESD Protection

UM232EExE devices have standard ESD protection structures incorporated on the pins to protect against electrostatic discharges encountered during assembly and handling. In addition, the RS-232 bus pins (driver outputs and receiver input) of these devices have an extra level of ESD protection. Advanced ESD structures were designed to successfully protect these pins against ESD discharge of ± 15 kV Human Body Model when powered down or up.





Test Circuits

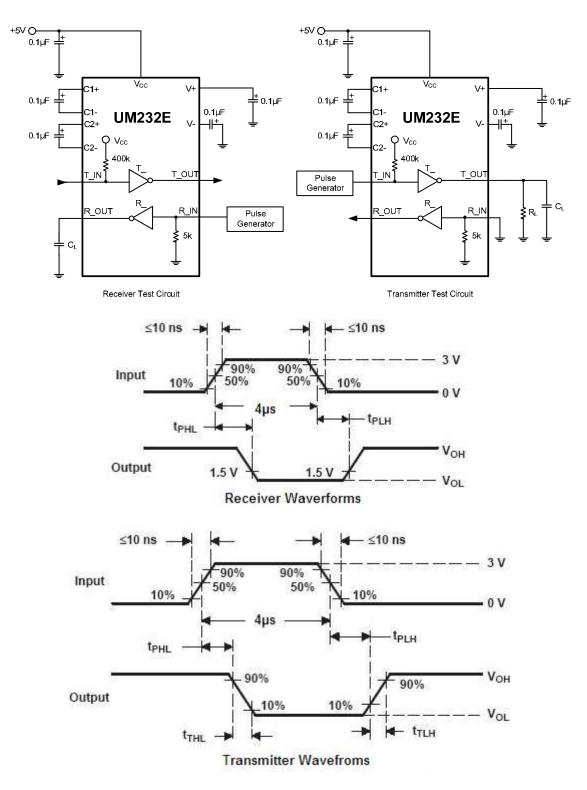
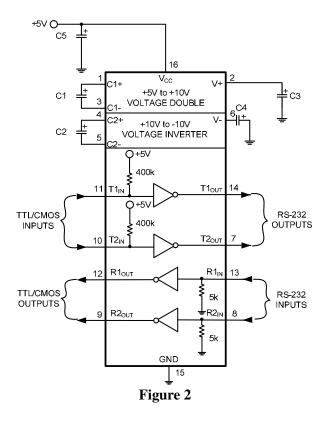


Figure 1



Typical Operating Circuits



Applications Information

Capacitor Selection

The capacitor type used for C1–C4 is not critical for proper operation. The UM232EExE, require 0.1 μ F capacitors, although in all cases capacitors up to 10 μ F can be used without harm. Ceramic dielectrics are suggested for the 0.1 μ F capacitors. When using the minimum recommended capacitor values, make sure the capacitance value does not degrade excessively as the operating temperature varies. If in doubt, use capacitors with a larger (e.g., 2x) nominal value. The capacitors' effective series resistance (ESR), which usually rises at low temperatures, influences the amount of ripple on V₊ and V-. Use larger capacitors (up to 10 μ F) to reduce the output impedance at V₊ and V-. Bypass V_{CC} to ground with at least 0.1 μ F capacitor. In applications sensitive to power-supply noise generated by the charge pumps, decouple V_{CC} to ground with a capacitor the same size as (or larger than) the charge pump capacitors (C1–C4).

V+ and V- as Power Supplies

A small amount of power can be drawn from V₊ and V-, although this will reduce both driver output swing and noise margins. Increasing the value of the charge-pump capacitors (up to 10μ F) helps maintain performance when power is drawn from V₊ or V-.

Driving Multiple Receivers

Each transmitter is designed to drive a single receiver. Transmitters can be paralleled to drive multiple receivers.

High Data Rates

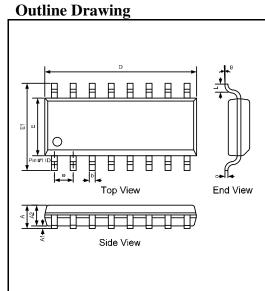
These transceivers maintain the RS-232 ± 5.0 V minimum driver output voltages at data rates of over 250 kbps.





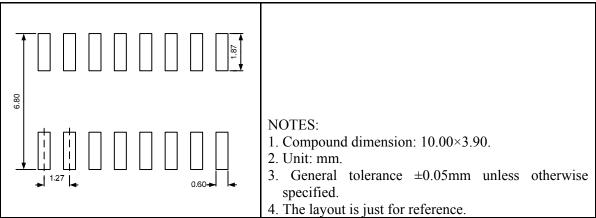
Package Information

UM232EESE SOP16

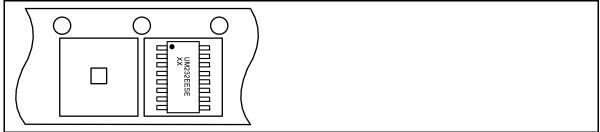


DIMENSIONS									
a 1 1	MII	MILLIMETERS			INCHES				
Symbol	Min	Тур	Max	Min	Тур	Max			
А	1.35	1.60	1.75	0.053	0.063	0.069			
A1	0.10	-	0.25	0.004	-	0.010			
A2	1.25	1.45	1.65	0.049	0.057	0.065			
b	0.33	-	- 0.51 0.013		-	0.020			
c	0.17	-	0.25	0.007 -		0.010			
D	9.80	10.00	10.20	0.386	0.394	0.402			
Е	3.80	3.90	4.00	0.150	0.154	0.157			
E1	5.80	6.00	6.20	0.228	0.236	0.244			
e		1.27BS	2	0	.050BS0	2			
L	0.40	-	1.27	0.016	-	0.050			
θ	0°	-	8°	0°	-	8°			

Land Pattern



Tape and Reel Orientation







UM232EEPE DIP16

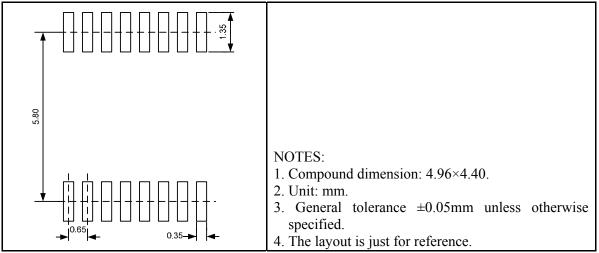
Outline Drawing										
		DIMENSIONS								
		Symbol	MILLIMETERS		ERS	INCHES				
_	-	Symbol	Min	Тур	Max	Min	Тур	Max		
		А	3.71	4.01	4.31	0.146	0.158	0.170		
			0.51	-	-	0.020	-	-		
		A2	3.20	3.40	3.60	0.126	0.134	0.142		
	E2	b	0.38	0.48	0.57	0.015	0.019	0.022		
Top View E	End View	b1		1.52BSC		0	.060BS0	2		
		с	0.20	0.28	0.36	0.008	0.011	0.014		
		D	18.80	19.00	19.20	0.740	0.748	0.756		
		Е	6.20	6.40	6.60	0.244	0.252	0.260		
→l ^{b1} l→ →l→b Side View		E1	7.32	7.62	7.92	0.288	0.300	0.312		
Side view		E2	8.40	8.70	9.00	0.331	0.343	0.354		
	e	4	2.54BSC	2	0	.100BS0	C			
		L	3.00	3.30	3.60	0.118	0.130	0.142		



Outline Drawing										
	DIMENSIONS									
		Symbol	MILLIMETERS			INCHES		5		
		Symbol	Min	Тур	Max	Min	Тур	Max		
		Α	I	-	1.20	-	-	0.047		
<u> </u> ↑		A1	0.05	-	0.15	0.002	-	0.006		
		A2	0.80	-	1.05	0.031	-	0.041		
		A3	0.34	0.44	0.54	0.013	0.017	0.021		
μ		b	0.19	-	0.30	0.007	-	0.012		
		с	0.09	-	0.20	0.004	-	0.008		
<u> ; ;</u> Pin#11D		D	4.86	4.96	5.10	0.191	0.195	0.201		
╚╚╙╙╙╙╙╙ <u></u>		Е	4.30	4.40	4.50	0.169	0.173	0.177		
Top View	End View	E1	6.20	6.40	6.60	0.244	0.252	0.260		
		e	0.65BSC		0.026BSC					
		L	0.45	0.60	0.75	0.018	0.024	0.030		
╡ <mark>┊┊┊┊┊┊</mark>		L1		1.00REI	- -	0	0.039RE	F		
Side View		L2	(0.25BSC	C	0	0.010BS	C		
	→ ∞ 7	θ1	0°	-	8°	0°	-	8°		
		θ2	10°	12°	14°	10°	12°	14°		
		θ3	10°	12°	14°	10°	12°	14°		

UM232EEUE TSSOP16

Land Pattern



Tape and Reel Orientation





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